S. PATENT AND TRADEMARK OFFICE

Case Docket No. <u>990150</u>

U.S. DEPARTMENT OF COMMERCE

05-07-1999

and Trademark Office

RECOR

To the As

Please record the accents or copy thereof.

1. Name of conveying party(ies):

Chihiro MAKARA and Tetsuji KADOWAKI

Additional name(s) of conveying party(ies) attached?

2. Name and address of receiving party(ies):

Name: FUJITSU LIMITED

Street Address:

1-1, Kamikodanaka 4-chome, Nakahara-ku, Kawasaki-shi, Kanagawa 211-8588, Japan

Additional name(s) & address(es) attached? NO

3. Nature of conveyance: Assignment

Execution Date: February 12, 1999

4. Title: APPARATUS FOR CONVEYANCE OF SEMICONDUCTOR CHIPS

9.266819

5. Application number(s) or patent number(s):

If this document is being filed together with a new application, the execution date of the application is: February 12, 1999

A. Patent Application No.(s) B. Patent No.(s)

Additional numbers attached? NO

PATENT **REEL: 9751 FRAME: 0573**

6. Name and address of party to whom correspondence concerning document should be mailed:				
Name: Armstrong, Westerman, Hattori, McLeland & Naughton Suite 1000 1725 K Street, N.W. Washington, D.C. 20006				
7. Total number of applications and patents involved: 1				
8. Total fee (37 CFR 3.41)				
XX Check enclosed				
9. Deposit Account No.: <u>01-2340</u>				
To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document. Date March 12, 1999 William F. Westerman Reg. No.: 29,988				
Total number of pages including cover sheet: 3				

WFW/yap

PATENT REEL: 9751 FRAME: 0574

Armstrong, V	Westerman,	Hattori,	McLeland	&	Naughton
--------------	------------	----------	----------	---	----------

		Docket No.				
	U.S. ASSIC	GNMENT				
	IN CONSIDERATION of the su consideration paid to the undersigne					
(Insert ASSIGNEE's	FUJITSU LIMITED		•			
Name(s) Address(es))	1-1, Kamikodanaka 4-cho	me, Nakahara-ku, Kawasak	i-shi,			
	Kanagawa 211-8588 Japan	1				
	(hereinaster ASSIGNEE), the receip hereby sells, assigns and transfers t the invention entitled					
(Title of Invention)	APPARATUS FOR CONVEYANO	CE OF SEMICONDUCTOR CHIPS	3			
(*If the assignment is being filed after the filing of the application, this						
section must be	*filed on	Serial No.				
completed)						
	code, serial number and/or filing date hereon, when known)					
	and all Letters Patent of the Unicontinuation, divisional, substitute, which the same may be granted.					
	The ASSIGNOR agrees to execute all papers necessary in connection with the application and any continuation, divisional, reissue or reexamination applications thereof and also to execute separate assignments in connection with such applications as the ASSIGNEE may deem necessary or expedient.					
	The ASSIGNOR agrees to exec litigation, or other legal proceeding continuation, divisional, reissue or thereon and to cooperate with the evidence and proceeding with such	reexamination thereof or Letters P ASSIGNEE in every way possible	ning this application or any atent or reissue patent issued in obtaining and producing			
	IN WITNESS WHEREOF, the un	dersigned inventor(s) has (have) affi	xed his/her/their signature(s).			
(6)	Chilia & Ball	Chihiro MAYADA	February 12, 1999			
(Signatures)	(SIGNATURE)	Chihiro MAKARA (TYPE NAME)	(DATE)			
	,	,	, ,			
	Tetsuji Kadowaki (SIGNATURE)	Tetsuji KADOWAKI	February 12, 1999			
	(SIGNATUKE)	(TYPE NAME)	(DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			
	(SIGNATURE)	(TYPE NAME)	(DATE)			

RECORDED: 03/12/1999

PATENT REEL: 9751 FRAME: 0575